

#### **Product Version: V2**

#### **Key Features**

- High-end security controller
- Common Criteria Certified EAL6+ (high) hardware
- Turnkey solution
- Up to 10kB user memory
- PG-USON-10-2,-4 package (3 x 3 mm)
- Standard & Extended temperature ranges
- I2C interface with Shielded Connection (encrypted communication)
- Cryptographic support:
  - o RSA® up to 2048,
  - o AES key up to 256, HMAC up to SHA512,
  - o TLS v1.2 PRF and HKDF up to SHA512
- OPTIGA™ Trust M2 ID2 Software Framework on Github <a href="https://github.com/Infineon/optiga-trust-m">https://github.com/Infineon/optiga-trust-m</a>
- Crypto ToolBox commands for SHA-256, RSA® Feature, AES, HMAC and Key derivation
- Alibaba Cloud IoT connectivity
- Configurable device security monitor, 4 Monotonic up counters
- Protected(integrity and confidentiality) update of data, key and metadata objects
- Hibernate for zero power consumption<sup>1</sup>
- Lifetime for Industrial Automation and Infrastructure is 20 years and 15 years for other Application Profiles

#### **Benefits**

- · Protection of IP and data
- Protection of business case and corporate image
- Safeguarding of quality and safety

#### **Applications**

- Industrial control and building automation
- Consumer electronics, Smart Home and Drones

#### **About this document**

#### Scope and purpose

This Datasheet provides information to enable integration of a security device, and includes package, connectivity and technical data.

#### Intended audience

This Datasheet is intended for device integrators and board manufacturers.

<sup>&</sup>lt;sup>1</sup> Leakage current < 2.5μA only



## Product Version: V2 Table of Contents



## **Table of Contents**

Abou	t this documentt	1
Table	e of Contents	2
1	Introduction	4
1.1	Broad range of benefits	4
1.2	Enhanced security	4
1.3	Fast and easy integration	4
1.4	Applications	4
1.5	Device Features	4
2	System Block Diagram	7
3	Interface and Schematics	9
3.1	System Integration Schematics	
3.2	System Integration Schematics with Hibernation support	9
4	Description of packages	10
4.1	PG-USON-10-2,-4	10
4.2	Production sample marking pattern	11
5	Technical Data	13
5.1	I2C Interface Characteristics	13
5.1.1	I2C Standard/Fast Mode Interface Characteristics	13
5.1.2	I2C Fast Mode Plus Interface Characteristics	
5.1.3	Electrical Characteristics	
5.1.3.		
5.1.3.		
5.1.4	Start-Up of I2C Interface	
5.1.4.	· ·	
5.1.4.	•	
6	Connecting to Host	
6.1	OPTIGA™ Trust M2 ID2 Host Software Architecture	
6.2	Release Package Folder Structure	
6.3	Porting Notes	
6.4 6.5	Reference code on XMC4800 for communicating with OPTIGA™ Trust M2 ID2	
7	OPTIGA™ Trust M2 ID2 External Interface	
7.1 7.2	Commands Crypto Performance	
	• •	
8 0 1	Security Monitor	
8.1 8.2	Security Policy	
	Security Policy	
9	RoHS Compliance	
10	Appendix A – Infineon I2C Protocol Registry Map	
10.1	Infineon I2C Protocol Variations	
11	Appendix B - OPTIGA™ Trust M2 ID2 Command/Response I2C Sample Logs	
11.1	Sequence of commands to read Coprocessor UID from OPTIGA™ Trust M2 ID2	
11.1.1	. – .	
11.1.2	! !!	
11.1.3	Read Coprocessor UID	35

## **Product Version: V2**



## **Table of Contents**

12	Appendix C - Power Management	37
	Hibernation	
12.2	Low Power Sleep Mode	37
Revis	sion history	38

#### **Product Version: V2**

Introduction

# infineon

## 1 Introduction

As embedded systems (e.g. IoT devices) are increasingly gaining the attention of attackers, Infineon offers the OPTIGA™ Trust M2 ID2 as a turnkey security solution for industrial automation systems, smart homes, consumer devices and medical devices. This high-end security controller comes with full system integration support for easy and cost-effective deployment of high-end security for your assets.

## 1.1 Broad range of benefits

Integrated into your device, the OPTIGA™ Trust M2 ID2 supports protection of your brand and business case, differentiates your product from your competitors, and adds value to your product, making it stronger against cyberattacks.

### 1.2 Enhanced security

The OPTIGA™ Trust M2 ID2 is based on an advanced security controller with built-in tamper proof NVM for secure storage and Symmetric/Asymmetric crypto engines to support RSA® up to 2048, AES key up to 256, HMAC up to SHA512, HKDF up to SHA512 and SHA-256. This new security technology greatly enhances your overall system security.

### 1.3 Fast and easy integration

The turnkey setup – with full system integration and all key/certificate material preprogrammed – reduces your efforts for design, integration and deployment to a minimum. As a turnkey solution, the OPTIGA™ Trust M2 ID2 comes with preprogrammed OS/Application code locked and with host-side modules to integrate with host micro controller software. The temperature range of −40°C to +105°C combined with a standardized I2C interface and the small PG-USON-10-2,-4 footprints will facilitate onboarding in your existing ecosystem. Almost 30 years in a market-leading position with nearly 20 billion security controllers shipped worldwide are the results of Infineon's strong expertise and its commitment to make security a success factor for you.

## 1.4 Applications

The OPTIGA™ Trust M2 ID2 covers a broad range of use cases necessary for many types of applications that include the following:

- a) Network node protection using Mutual Authentication such as TLS or DTLS
- b) Protect the Authenticity, Integrity and Confidentiality of your product, data and IP
- c) Secure Communication
- d) Datastore Protection
- e) Lifecycle Management
- f) Platform Integrity Protection
- g) Secure Updates

#### 1.5 Device Features

The OPTIGA™ Trust M2 ID2 comes with up to 10kB of user memory that can be used to store X.509 certificates and data. OPTIGA™ Trust M2 ID2 is based on Common Criteria (CC) Certified EAL6+ (high) hardware enabling it to prevent physical attacks on the device itself and providing high assurance that the keys or arbitrary data stored cannot be accessed by an unauthorized entity. The CC certificate can be found at <a href="https://www.bsi.bund.de">www.bsi.bund.de</a> by

#### **Product Version: V2**



#### Introduction

searching for BSI-DSZ-CC-0961 (Hardware Identifier IFX\_CCI\_00000Bh) and referring to the latest CC certificate. OPTIGA™ Trust M2 ID2 supports a highspeed I2C communication interface of up to 1MHz (FM+).

Table 1 Products

Sales Code	Temperature range	Package	Description	Evaluation Kit
OPTIGA™ Trust M2 ID2 SLS 32AIA010I2	-40°C to +105°C Extended Temperature Range (ETR)	PG-USON- 10-2,-4	Embedded security solution for connected devices	XMC4800 IoT Connectivity Kit connected to the OPTIGA™ Trust M2 ID2 to
OPTIGA™ Trust M2 ID2 SLS 32AIA010I3	−25°C to +85°C Standard Temperature Range (STR)	PG-USON- 10-2,-4		connect to the outside world.

Infineon and its distribution partners offer a wide range of customization options (e.g. X.509 certificate generation and key provisioning) for the security chip.

Table 2 Features

Features	Supported Curve/Algorithm	ToolBox commands			
RSA®	RSA® 1024/2048	Sign, Verify, Key generation, Encrypt and Decrypt			
Kara Davination	TLS v1.2 PRF SHA 256/384/512	TLS PRF using SHA 256/384/512			
Key Derivation	HKDF SHA-256/384/512	HKDF using SHA256/384/512			
AES	Key size - 128/192/256 (ECB, CBC, CBC-MAC, CMAC)	Key generation, Encrypt and Decrypt			
Random generation	TRNG, DRNG, Pre-Master secret for RSA® Key exchange	Generate random			
HMAC	HMAC with SHA256/384/512	HMAC generation and Verification			
Hash	SHA 256	Hash generation			
Protected Data/key/metadata update (Integrity and/or confidentiality)	ECC NIST P256/384/521 ECC Brainpool P256/384/512 r1 RSA® 1024/2048 Signature scheme as ECDSA FIPS 186-3/RSA SSA PKCS#1 v1.5 without	Secure data/key object update and metadata update for Data/key object			
	hashing				

## **Product Version: V2**



## Introduction

#### Table 3 Abbreviations

Abbreviation	Definition
AES	Advanced Encryption Standard
API	Application Programming Interface
CA	Certification Authority
СС	Common Criteria
DRNG	Deterministic Random Number Generator
DTLS	Datagram Transport Layer Security
EAL	Evaluation Assurance Level
ECB	Electronic Code Book
ETR	Extended Temperature Range
CBC	Cipher block chaining
CBC-MAC	Cipher block chaining message authentication code
CMAC	Cipher-based message authentication code
HKDF	Hash-based key derivation function
I2C	Inter-Integrated Circuit
IETF	Internet Engineering Task Force
IFX	Infineon
IOT	Internet of Things
IP	Intellectual Property
NIST	National Institute of Standards and Technology
OS	Operating System
PAL	Platform Abstraction Layer
PKI	Public Key Infrastructure
RFC	Request For Comments
SHA	Secure Hash Algorithm
SKU	Stock Keeping Unit
STR	Standard Temperature Range
TLS	Transport Layer Security
TRNG	True Random Number Generator
USB	Universal Serial Bus
HMAC	Hash based Message Authentication Code

#### **System Block Diagram**



## 2 System Block Diagram

The following figure depicts the system block diagram for OPTIGA™ Trust M2 ID2.

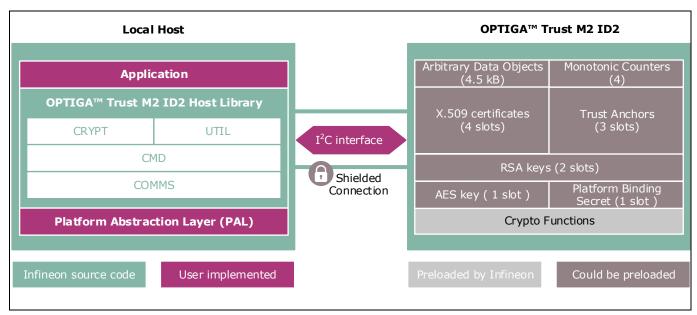


Figure 1 System Block Diagram

The System Block Diagram is explained below for each layer.

#### 1. Local Host

- Local Host Application This is the target application which utilizes OPTIGA™ Trust M2 ID2 for its security needs
- OPTIGA™ Trust M2 ID2 Host Library
  - CRYPT Provides APIs to perform cryptographic functionalities. Any TLS stack can be integrated on Local Host as part of 3<sup>rd</sup> party Crypto Library to offload crypto operations to OPTIGA™ Trust M2 ID2.
  - UTIL Provides APIs such as read/write, protected update of data, metadata, key objects and open/close application (e.g. Hibernate)
  - CMD Provides APIs to send and receive commands (Section 7) to and from OPTIGA™ Trust M2 ID2
  - COMMS Provides wrapper APIs for communication (optional encrypted communication using Shielded Connection) with OPTIGA<sup>TM</sup> Trust M2 ID2 which internally uses Infineon I2C Protocol (IFX I2C)
- PAL A layer that abstracts platform specific drivers (e.g. I2C, Timer, GPIO, platform crypto library etc.)

#### 2. OPTIGA™ Trust M2 ID2

- Arbitrary Data Objects The target application can store up to 4.5kB (~4600 bytes) of data into OPTIGA™ Trust M2 ID2. The data could be additional Trust Anchors, certificates and shared secret.
- Monotonic Counters Provides 4 monotonic counting data objects (up counters). These can be used as general purpose counter or as linked counter to other objects.

#### **Product Version: V2**



### **System Block Diagram**

For more information, please refer to Solution Reference Manual document available as part of the package.

- o X.509 Up to 4 X.509 based Certificates can be stored
- o Keys Up to 2 RSA and 1 AES based keys can be stored
- o Secret 1 Platform binding secret can be stored
- Trust Anchors 3 slots, for Mutual Authentication (TLS/DTLS) and Firmware Updates can be stored
- Crypto Functions OPTIGA™ Trust M2 ID2 provides cryptographic functions that can be invoked via local host

Note:

Unique AES key, RSA private keys and X.509 Certificates – During production at Infineon fab, unique asymmetric keys (private and public) are generated and symmetric key/shared secrets are provisioned. The public key is signed by customer specific CA and the resulting X.509 certificate issued is securely stored in the OPTIGA™ Trust M2 ID2. Special measures are taken to prevent the leakage and modification of private key/shared secret material at the Common Criteria Certified production site

#### **Interface and Schematics**

#### 3 Interface and Schematics

This section explains the schematics of the product and gives some recommendations as to how the controller should be externally connected.

### 3.1 System Integration Schematics

The following figure illustrates how to integrate OPTIGA™ Trust M2 ID2 with your local host.

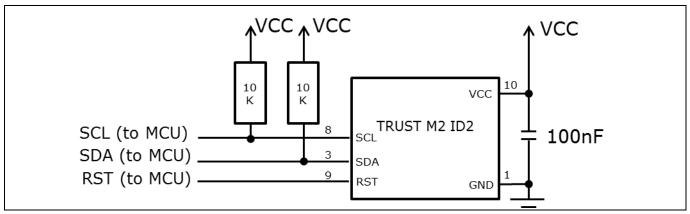


Figure 2 System Integration Schematic Diagram

Note: Value of the pullup resistors depend on the target application circuit and the target I2C frequency.

## 3.2 System Integration Schematics with Hibernation support

The following figure illustrates how to integrate OPTIGA™ Trust M2 ID2 with hibernation, with your local host.

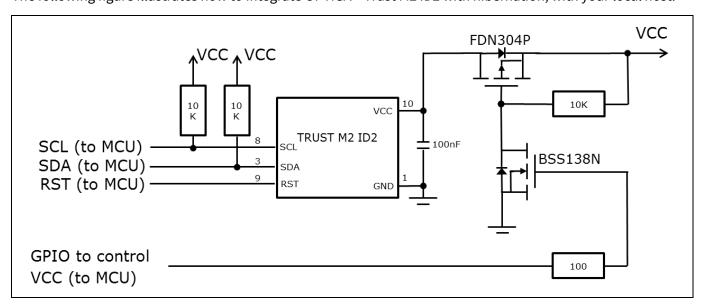


Figure 3 System Integration Schematic Diagram with Hibernation

Note: Value of the pullup resistors depend on the target application circuit and the target I2C frequency.

### **Description of packages**

## 4 Description of packages

This chapter provides information on the package types and how the interfaces of each product are assigned to the package pins. For further information on compliance of the packages with European Parliament Directives, see "RoHS Compliance" on Page 29.

For details and recommendations regarding the assembly of packages on PCBs, please see the following: <a href="http://www.infineon.com/cms/en/product/technology/packages/">http://www.infineon.com/cms/en/product/technology/packages/</a>

#### 4.1 PG-USON-10-2,-4

The package dimensions (in mm) of the controller in PG-USON-10-2,-4 packages are given below.

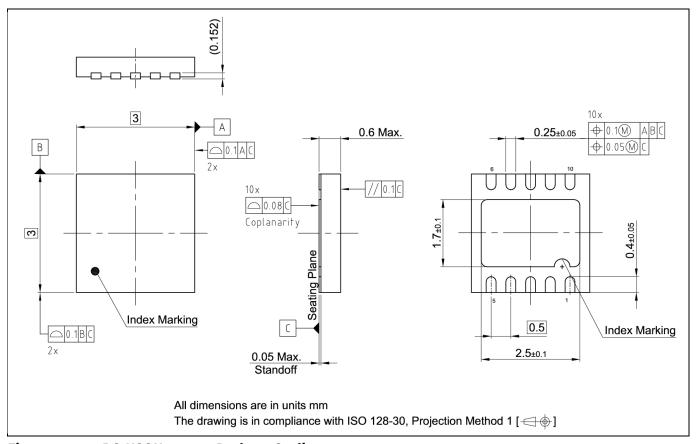


Figure 4 PG-USON-10-2,-4 Package Outline

### **Description of packages**

The following figure shows the PG-USON-10-2,-4 in top view:

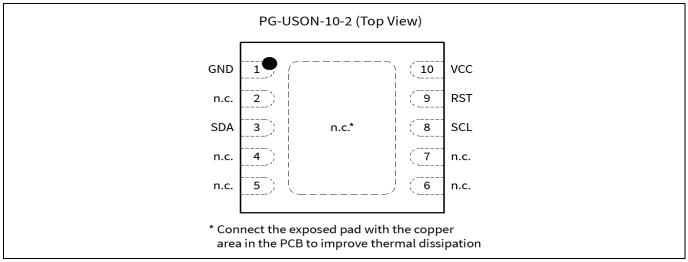


Figure 5 PG-USON-10-2,-4 top view

## 4.2 Production sample marking pattern

The following figure describes the productive sample marking pattern on PG-USON-10-2,-4.

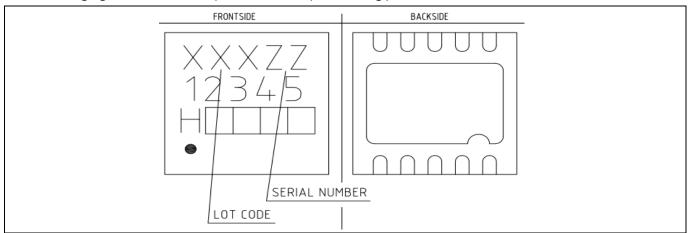


Figure 6 PG-USON-10-2,-4 sample marking pattern

The black dot indicates pin 01 for the chip. The following Table 4 describes the sample marking pattern:

Table 4 Marking table for PG-USON-10-2,-4 packages

Indicator	Description			
LOT CODE	Defined and inserted during fabrication			
ZZ	Indicates the Certifying Authority Serial Number / SKU#, e.g. "00" would			
	mean "SKU#00"			
H/E	H = "Halogen-free", E = "Engineering samples"			
	This indicator is followed by "YYWW", where YY is the "Year" and WW is			
	the "Work Week" of the production. This is inserted during fabrication.			
	Engineering samples have "E YYWW" and productive samples have "H			
-	YYWW"			

## **Product Version: V2**



## **Description of packages**

Indicator	Description
12345	Convention: T&#\$@ where:</td></tr><tr><td></td><td>The letter "T" indicates the OPTIGA Trust family</td></tr><tr><td></td><td>& indicates the product is a Trust M controller</td></tr><tr><td></td><td><ul>     <li># indicates the controller is a STR (S) variant</li> </ul></td></tr><tr><td></td><td>• \$ specifies the OPTIGA™ Trust M2 ID2 release version number</td></tr><tr><td></td><td>@ specifies the software version</td></tr><tr><td></td><td>Example: "TMS20" means 'OPTIGA™ Trust M2 ID2', 'STR variant', 'release version 1', 'software version 0'</td></tr></tbody></table>

The contacts and their functionality are given in the Table 5 below.

Table 5 Contact definitions and functions of PG-USON-10-2,-4 packages

Pin	Туре	Function				
01	GND	Supply voltage (Ground)				
02	NC	Not connected / Do not connect externally				
03	I/O	Serial Data Line (SDA)				
04	NC	Not connected / Do not connect externally				
05	NC	Not connected / Do not connect externally				
06	NC	Not connected / Do not connect externally				
07	NC	Not connected / Do not connect externally				
08	I/O	Serial Clock Line (SCL)				
09	IN	Active Low Reset (RST)				
10	PWR	Supply voltage (V <sub>CC</sub> )				

#### **Technical Data**

### 5 Technical Data

This section summarizes the technical data of the product. It provides the operational characteristics as well as the electrical DC and AC characteristics.

#### 5.1 I2C Interface Characteristics

Table 6 I2C Operation Supply and Input Voltages

Parameter	Symbol	Values			Unit	Note or Test Condition	
		Min.	Тур.	Max.			
Supply voltage	V <sub>CC_I2C</sub>	1.62	_	5.5	V		
SDA, SCL input voltage	V <sub>IN_I2C</sub>	-0.3	-	V <sub>CC_I2C</sub> + 0.5 or 5.5 <sup>1</sup>	V	V <sub>CC_I2C</sub> is in the operational supply range	
		-0.3	-	5.5	V	$V_{CC\_I2C}$ is switched off	

<sup>1)</sup> Whichever is lower

## **5.1.1** I2C Standard/Fast Mode Interface Characteristics

For operation of the I2C interface, the electrical characteristics are compliant with the I<sup>2</sup>C bus specification Rev. 4 for "standard-mode" ( $f_{SCL}$  up to 100 kHz) and "fast-mode" ( $f_{SCL}$  up to 400 kHz), with certain deviations as stated in the table below.

Note:  $T_A$  as given for the operating temperature range of the controller unless otherwise stated.

**Table 7 I2C Standard Mode Interface Characteristics** 

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
SCL clock frequency	$f_{SCL}$	0	-	100	kHz	
Input low-level	V <sub>IL</sub>	-0.3	_	0.3 * V <sub>CC_I2C</sub>	V	
Low-level output voltage	V <sub>OL1</sub>	0	-	0.4	V	Sink current 3 mA; $V_{CC_{12}C} \ge 2.7 \text{ V}$ Sink current 2 mA; $V_{CC_{12}C} < 2.7 \text{ V}$
Low-level output current	I <sub>OL</sub>	3 2	-	-	mA	$V_{OL} = 0.4 \text{ V}; V_{CC\_I2C} \ge 2.7 \text{ V}$ $V_{OL} = 0.4 \text{ V}; V_{CC\_I2C} < 2.7 \text{ V}$
Output fall time from V <sub>IHmin</sub> to V <sub>ILmax</sub> (at device pin)	t <sub>OF</sub>	-	-	250	ns	$C_b \le 400 \text{ pF}; V_{CC\_12C} \ge 2.7 \text{ V}$ $C_b \le 200 \text{ pF}; V_{CC\_12C} \le 2.7 \text{ V}$
Capacitive load for each bus line	Сь	-	-	400 200	pF	$V_{CC\_12C} \ge 2.7 \text{ V}$ $V_{CC\_12C} < 2.7 \text{ V}$

#### **Technical Data**

Table 8 I2C Fast Mode Interface Characteristics

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
SCL clock frequency	f <sub>SCL</sub>	0	-	400	kHz	
Input low-level	V <sub>IL</sub>	-0.3	-	0.3 * V <sub>CC_I2C</sub>	V	
Low-level output voltage	V <sub>OL1</sub>	0	-	0.4	V	Sink current 3 mA; $V_{CC_{12C}} \ge 2.7 \text{ V}$ Sink current 2 mA; $V_{CC_{12C}} < 2.7 \text{ V}$
Low-level output current	I <sub>OL</sub>	3 2	-	-	mA	$V_{OL} = 0.4 \text{ V}; V_{CC\_I2C} \ge 2.7 \text{ V}$ $V_{OL} = 0.4 \text{ V}; V_{CC\_I2C} < 2.7 \text{ V}$
Output fall time from V <sub>IHmin</sub> to V <sub>ILmax</sub> (at device pin)	t <sub>OF</sub>	20 * V <sub>CC_I2C</sub> / 5.5 V <sup>1</sup>	-	250	ns	$C_b \le 400 \text{ pF}; V_{CC\_12C} \ge 2.7 \text{ V}$ $C_b \le 200 \text{ pF}; V_{CC\_12C} \le 2.7 \text{ V}$
Capacitive load for each bus line	Сь	15 <sup>2</sup>	-	400 200	pF	$V_{CC\_12C} \ge 2.7 \text{ V}$ $V_{CC\_12C} < 2.7 \text{ V}$

<sup>1)</sup> A min. capacitive load is necessary to reach  $t_{\text{OF}}$ 

#### 5.1.2 I2C Fast Mode Plus Interface Characteristics

For operation of the I2C interface, the electrical characteristics are compliant with the  $I^2C$  bus specification Rev. 4 for "fast mode plus" ( $f_{SCL}$  up to 1 MHz), with certain deviations as stated in the table below.

Note:  $T_A$  as given for the operating temperature range of the controller unless otherwise stated.

**Table 9** I2C Fast Mode Plus Interface Characteristics

Parameter	Symbol	Values			Unit	<b>Note or Test Condition</b>
		Min.	Тур.	Max.		
SCL clock frequency	f <sub>SCL</sub>	0	_	1000	kHz	
Input low-level	V <sub>IL</sub>	-0.3	_	0.3 * V <sub>CC_I2C</sub>	٧	
Low-level output voltage	V <sub>OL1</sub>	0	-	0.4	V	Sink current 3 mA; $V_{CC\_12C} \ge 2.7 \text{ V}$ Sink current 2 mA; $V_{CC\_12C} < 2.7 \text{ V}$
Low-level output current	I <sub>OL</sub>	3 2	-	_	mA	$V_{OL} = 0.4 \text{ V}; V_{CC\_I2C} \ge 2.7 \text{ V}$ $V_{OL} = 0.4 \text{ V}; V_{CC\_I2C} < 2.7 \text{ V}$
Output fall time from V <sub>IHmin</sub> to V <sub>ILmax</sub> (at device pin)	t <sub>OF</sub>	20 * V <sub>CC_I2C</sub> / 5.5 V <sup>1</sup>	-	120	ns	C <sub>b</sub> ≤ 150 pF
Capacitive load for each bus line	C <sub>b</sub>	15 <sup>1</sup>	-	150	pF	

<sup>1)</sup> A min. capacitive load is necessary to reach  $t_{\text{OF}}$ 

<sup>2)</sup> A min. capacitive load is necessary to reach  $t_{\text{fmin}}$ 



#### **Technical Data**

#### 5.1.3 **Electrical Characteristics**

Note: T<sub>A</sub> as given for the operating temperature range of the controller unless otherwise stated. All

currents flowing into the controller are considered positive.

#### **DC Electrical Characteristics** 5.1.3.1

T<sub>A</sub> as given for the controller's operating ambient temperature range unless otherwise stated.

All currents flowing into the controller are considered positive.

**Electrical Characteristics** Table 10

Parameter	Symbol Values			Unit	Note or Test Condition	
		Min.	Тур.	Max.		
Supply voltage	<b>V</b> cc	1.62	_	5.5	V	Overall functional range
	V <sub>CC_I2C</sub>	1.62	-	5.5	V	Supply voltage range for operation of I2C
Supply current <sup>1</sup>	I <sub>CCAVG</sub>	-	14.0	-	mA	While running a typical authentication profile T <sub>A</sub> = 25°C; V <sub>CC</sub> = 5.0 V
Supply current, in sleep mode	I <sub>CCS3</sub>	-	70	100	μА	$T_A = 25^{\circ}\text{C}$ ; $V_{\text{CC\_I2C}} = 3.3 \text{ V}$ ; I2C ready for operation (no bus activity), all other inputs at $V_{\text{CC}}$ , no other interface activity
RST input low voltage	V <sub>IL</sub>	-0.3	_	0.3 * V <sub>cc</sub>	V	$I_{IL} = -50 \mu\text{A} \text{ to } +20 \mu\text{A}$
RST input high voltage	V <sub>IH</sub>	0.7 * V <sub>cc</sub>	-	$V_{CC} + 0.3$	V	$I_{IL} = -50 \mu\text{A} \text{ to } +20 \mu\text{A}$
Hibernate current	-	_	< 2.5	-	μΑ	V <sub>cc</sub> = 0 V, GND = 0 V, RST = 0 V, SCL= 3.3 V and SCL = 3.3 V

<sup>1)</sup> Supply current can be limited from 6mA to 15mA by software commands.

#### **AC Electrical Characteristics** 5.1.3.2

T<sub>A</sub> as given for the controller's operating ambient temperature range unless otherwise stated. All currents flowing into the controller are considered positive.

Table 11 **AC Characteristics** 

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
V <sub>CC</sub> rampup time	t <sub>VCCR</sub>	1	-	1000	μs	400 mV to 90% of V <sub>cc</sub> target voltage ramp

The V<sub>CC</sub> ramp is depicted in Figure 7. 90% of the target supply voltage must be reached within t<sub>VCCR</sub> after it has exceeded 400 mV. Moreover, its variation must be kept within a ±10% range.

#### **Technical Data**

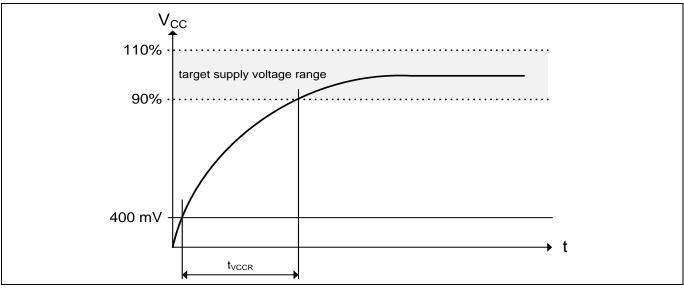


Figure 7 V<sub>cc</sub> Rampup

## 5.1.4 Start-Up of I2C Interface

There are 2 variants possible for performing the startup procedure:

- Startup after power-on
- Startup for warm resets

#### 5.1.4.1 Startup after Power-On

The activation of the I2C interface after power-on needs the following reset procedure.

- VCC is powered up and the state of the SDA and SCL line are set to high level during power-up
- The first transmission may start at the earliest  $t_{\text{STARTUP}}$  after power-up of the device

The following figure shows the startup timing of the I2C interface for this case.

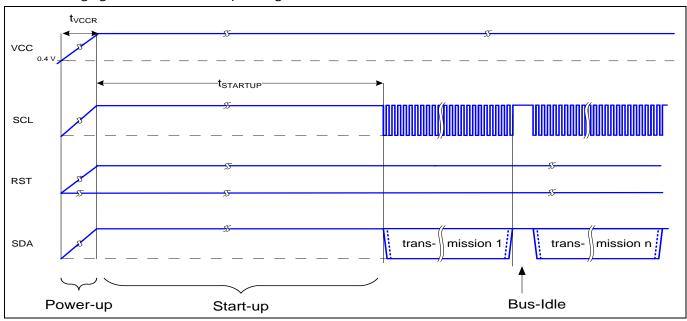


Figure 8 Startup of I2C Interface after Power-On

#### **Technical Data**

Table 12 Startup of I2C Interface After Power-On

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
Startup time	t <sub>STARTUP</sub>	15	_	_	ms	

#### **5.1.4.2** Startup for Warm Resets

When using the reset signal for triggering a warm reset after power-on, the activation of the I2C interface needs the following reset procedure

- VCC remains powered up.
- The terminal stops I2C communication. SDA and SCL lines are set to high level before RST is set to low level.
- After its falling edge, RST has to be kept at low level for at least t<sub>1</sub>. At the latest t<sub>2</sub> after the falling edge of RST, the terminal must set RST to high level.
- The first transmission may start at the earliest t<sub>STARTUP</sub> after the rising edge of RST

The following figure shows the timing for this startup case.

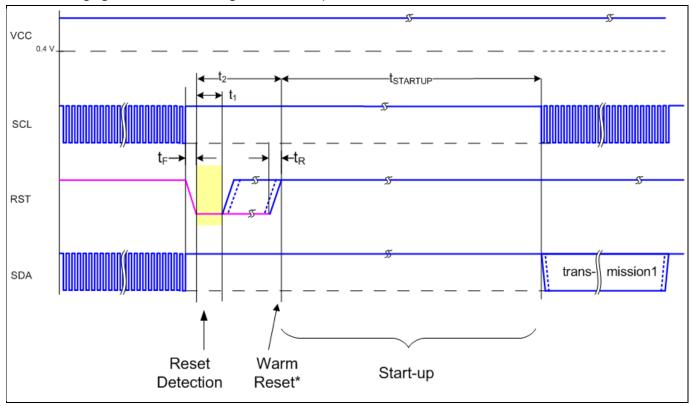


Figure 9 Startup of I2C Interface for Warm Resets

Note: If NVM programming was requested prior to the reset, t<sub>STARTUP</sub> will be extended from a typical value of 15 ms to a maximum of 20 ms.

**Product Version: V2** 

# infineon

### **Technical Data**

Table 13 Startup of I2C Interface for Warm Resets<sup>1</sup>

Parameter	Symbol	Values			Unit	<b>Note or Test Condition</b>
		Min.	Тур.	Max.		
Startup time	t <sub>STARTUP</sub>	15	_	_	ms	
Rise time	t <sub>R</sub>	_	-	1	μs	From 10% to 90% of signal amplitude
Fall time	t <sub>F</sub>	_	-	1	μs	From 10% to 90% of signal amplitude
Reset detection	t <sub>1</sub>	10	_	_	μs	
Reset low		10	_	2500	μs	

<sup>1)</sup> Reset triggered by software (without power off/on cycle)

### **Connecting to Host**

## **6** Connecting to Host

#### 6.1 OPTIGA™ Trust M2 ID2 Host Software Architecture

The OPTIGA™ Trust M2 ID2 Host Library layers were explained in System Block Diagram Figure 1. In following sections, we will cover how to communicate with OPTIGA™ Trust M2 ID2 using I2C.

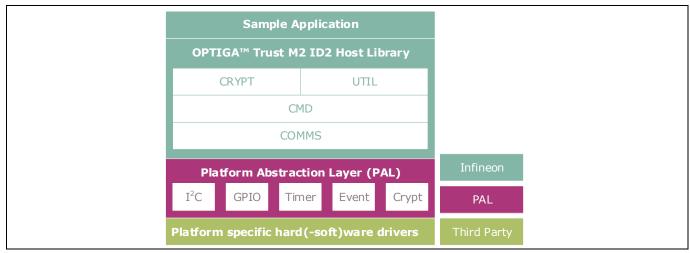
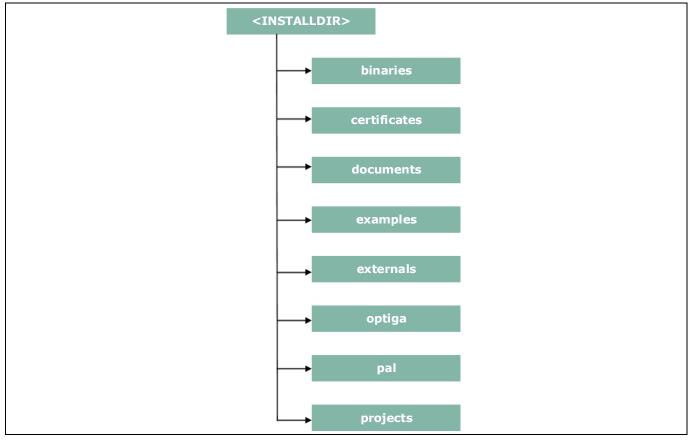


Figure 10 OPTIGA™ Trust M2 ID2 Host Software Architecture

## 6.2 Release Package Folder Structure

The following figure shows the release package structure when OPTIGA™ Trust M2 ID2 is installed/extracted on PC.



#### **Product Version: V2**

# infineon

### **Connecting to Host**

#### Figure 11 Release Package Folder Structure

<INSTALLDIR> is the root directory to which the release package contents are extracted. The following section explains the contents of each subdirectory under installed directory:

#### 1. binaries

This directory contains binaries for OPTIGA™ Trust M2 ID2 sample application.

#### 2. certificates

This directory contains OPTIGA™ Trust M2 ID2 certificates.

#### 3. documents

This directory contains all relevant OPTIGA™ Trust M2 ID2 documentation.

#### 4. examples

This directory contains example usecases for Toolbox features, AliOS irot HAL integration example files and a tool for generation of manifest for secure update of data and key object feature.

#### 5. externals

This directory contains mbedtls software crypto libraries and AliOS irot HAL integration file.

#### 6. optiga

This directory contains OPTIGA™ Trust M2 ID2 libraries.

#### 7. pal

This directory contains PAL for XMC4800 device and for mbedtls.

#### 8. projects

This directory contains XMC4800 device sample project in DAVE™ workspace.

Further the following figure elaborates the OPTIGA™ Trust M2 ID2 Host Software folder structure.

#### **Connecting to Host**

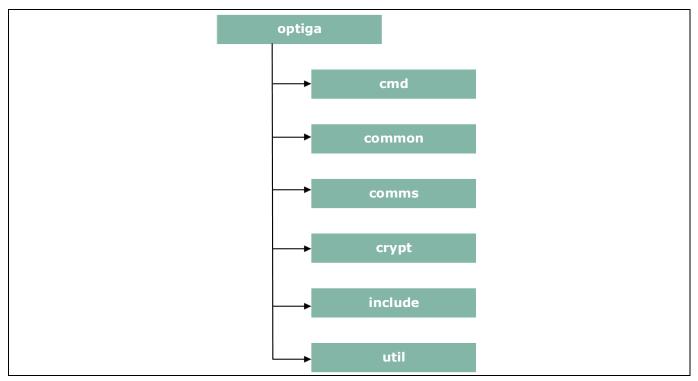


Figure 12 Host Source Folder Structure

- cmd This folder contains sources for all OPTIGA™ Trust M2 ID2 commands
- 2. common This folder contains the common functions used across all the modules
- 3. comms This folder contains the driver to communicate with OPTIGA™ Trust M2 ID2
- 4. crypt This folder contains sources for cryptographic functionalities
- 5. include This folder contains header files for all OPTIGA™ Trust M2 ID2 Host Software
- 6. util This folder contains utility functions e.g. read/write and open/close application

### 6.3 Porting Notes

The implementation of Platform Abstraction Layer (PAL) needs to be updated in order to migrate to a new target platform.

The PAL reference code for the XMC4800 IoT connectivity kit is provided as part of package which can be used. The implementation can be found in "<INSTALLDIR>/pal/xmc4800" and the header files are available in "<INSTALLDIR>/optiga/include" with the required APIs used by upper layers. The header files are platform agnostic and would not require any changes. The low level drivers used by PAL for XMC4800 are configured and generated using DAVE™.

#### 6.4 Communication with OPTIGA™ Trust M2 ID2

The hardware/platform resource configuration with respect to I2C master and GPIOs (Vdd and Reset) are to be updated in *pal\_ifx\_i2c\_config.c*. These configurations are used by the IFX I2C implementation to communicate with OPTIGA™ Trust M2 ID2.

1. Update I2C master platform specific context[e.g. (void\*)&i2c\_master\_0]

001	/**
001	* \brief PAL I2C configuration for OPTIGA
001	*/
002	pal_i2c_t optiga_pal_i2c_context_0 =

#### **Product Version: V2**



#### **Connecting to Host**

```
003
004
                 /// Pointer to I2C master platform specific context
005
                  (void*) &i2c master 0,
006
                 /// Slave address
007
                 0x30,
008
                 /// Upper layer context
009
                 NULL,
010
                 /// Callback event handler
011
                 NULL
012
            };
```

2. Update platform specific context for GPIOs (Vdd and Reset)

```
001
002
             * \brief Vdd pin configuration for OPTIGA
            */
003
004
            pal gpio t optiga vdd 0 =
005
006
                 // Platform specific GPIO context for the pin used to toggle Vdd
007
                 (void*) &vdd pin
800
            };
009
010
            /**
011
             * \brief Reset pin configuration for OPTIGA
012
013
            pal gpio t optiga reset 0 =
014
015
                 // Platform specific GPIO context for the pin used to toggle Reset
016
                 (void*) & reset pin
017
            };
```

3. Update PAL I2C APIs [pal\_i2c.c] to communicate with OPTIGA™ Trust M2 ID2

The pal\_i2c is expected to provide the APIs for I2C driver initialization, de-initialization, read, write and set bitrate kind of operations

- a) pal\_i2c\_init
- b) pal\_i2c\_deinit
- c) pal\_i2c\_read
- d) pal i2c write
- e) pal\_i2c\_set\_bitrate

A few target platforms, the I2C master driver initialization (<code>pal\_i2c\_init</code>) is done during the platform start up. In such an environment, there is no need to implement <code>pal\_i2c\_init</code> and <code>pal\_i2c\_deinit</code> functions. Otherwise, these (<code>pal\_i2c\_init</code> & <code>pal\_i2c\_deinit</code>) functions must be implemented as per the upper layer expectations based on the need. The details of these expectations are available in the Host library API documentation (chm).

The reference implementation of PAL I2C based on XMC4800 IoT connectivity kit does not need to have the platform I2C driver initialization explicitly done as part of  $pal\_i2c\_init$  as it is taken care by the DAVE<sup>TM</sup> library initialization. Hence  $pal\_i2c\_init$  &  $pal\_i2c\_deinit$  are not implemented.

In addition to the above specified APIs, the PAL I2C must handle the events from the low level I2C driver and invoke the upper layer handlers registered with PAL I2C context for the respective transaction as shown in the below example.

#### **Product Version: V2**



### **Connecting to Host**

In above example the I2C driver callback, when transmission is successful invokes the handler to inform the result.

- 4. Update PAL GPIO [pal\_gpio.c] to power on and reset the OPTIGA™ Trust M2 ID2
  - a) pal\_gpio\_set\_high
  - b) pal gpio set low
- 5. Update PAL Timer [pal\_os\_timer.c] to enable timer
  - a) pal\_os\_timer\_get\_time\_in\_milliseconds
  - b) pal\_os\_timer\_delay\_in\_milliseconds
- 6. Update Event management for the asynchronous interactions for IFX I2C [pal\_os\_event.c]
  - a) pal\_os\_event\_register\_callback\_oneshot
  - b) pal\_os\_event\_trigger\_registered\_callback

The *pal\_os\_event\_register\_callback\_oneshot* function is expected to register the handler and context provided as part of input parameters and triggers the timer for the requested time. The p\_pal\_os\_event is an event instance created using *pal\_os\_event\_create*.

```
001
          void pal os event register callback oneshot(
002
                                           pal os event t * p pal os event,
003
                                           register callback callback,
004
                                           void* callback args,
005
                                           uint32 t time us)
006
           {
               p pal os event->callback registered = callback;
007
008
               p pal os event->callback ctx = callback args;
009
010
               //lint --e{534} suppress "Return value is not required to be checked"
               TIMER SetTimeInterval(&scheduler timer, (time us*100));
011
012
               TIMER Start (&scheduler timer);
013
```

The handler registered must be invoked once the timer has elapsed as shown in pal\_os\_event\_trigger\_registered\_callback. The pal\_os\_event\_trigger\_registered\_callback is to be registered with event timer interrupt to get trigerred when the timer expires. The pal\_os\_event\_0 is the instance in the pal\_os\_event used store the registered callback and context.

```
001
           void pal os event trigger registered callback(void)
002
003
               register callback callback;
004
005
               TIMER ClearEvent (&scheduler timer);
006
               //lint --e{534} suppress "Return value is not required to be checked"
               TIMER Stop(&scheduler timer);
007
800
               TIMER Clear (&scheduler timer);
009
010
               if (pal os event 0.callback registered)
```



### **Connecting to Host**

## 6.5 Reference code on XMC4800 for communicating with OPTIGA™ Trust M2 ID2

```
001
          static volatile uint32 t optiga pal event status;
          static void optiga pal i2c event handler (void* upper layer ctx,
002
003
          uint8 t event);
004
005
          pal i2c t optiga pal i2c context 0 =
006
007
               /// Pointer to I2C master platform specific context
800
               (void*)&i2c master 0,
               /// Slave address
009
010
              0x30.
011
              /// Upper layer context
012
              NULL,
013
              /// Callback event handler
014
              NULL,
015
          };
016
017
          // OPTIGA pal i2c event handler
          static void optiga pal i2c event handler (void* upper layer ctx,
018
019
                                                       uint8 t event)
020
          {
021
              optiga pal event status = event;
022
          }
023
          /* Function to verify I2C communication with OPTIGA */
024
          pal status t test optiga communication(void)
025
026
              pal status t pal return status;
027
              uint8 t data buffer[10] = \{0x82\};
028
029
              // set callback handler for pal i2c
              optiga pal i2c context 0.upper layer event handler =
030
031
                                      optiga pal i2c event handler;
032
033
              // Send 0x82 to read I2C STATE from optiga
034
              do
035
               {
036
                    optiga pal event status = PAL I2C EVENT BUSY;
037
                    pal return status =
038
                               pal i2c write (&optiga pal i2c context 0,
039
                                              data buffer,
040
                                              1);
041
                   if (PAL STATUS FAILURE == pal return status)
042
043
                     // Pal I2C write failed due to I2C busy is in busy
                      // state or low level driver failures
044
045
                       break;
```



#### **Connecting to Host**

```
047
048
               // Wait until writing to optiga is completed
049
               } while (PAL I2C EVENT SUCCESS != optiga pal event status);
050
051
              // Read the I2C STATE from OPTIGA
052
053
              do
054
               {
055
                   optiga pal event status = PAL I2C EVENT BUSY;
056
                   pal return status =
                                 pal i2c read(&optiga pal i2c context 0 ,
057
058
                                               data buffer ,
059
                                               4);
                 // Pal I2C read failed due to I2C busy is in busy
060
                 // state or low level driver failures
061
062
                 if (PAL STATUS FAILURE == pal return status)
063
064
                       break;
065
               // Wait until reading from optiga is completed
066
067
              } while (PAL I2C EVENT SUCCESS != optiga pal event status);
068
069
              return pal return status;
070
          }
071
          /* Main Function */
072
073
          int32 t main(void)
074
          {
075
              DAVE STATUS t status;
076
              pal status t pal return status;
077
078
              // Initialisation of DAVE Apps
              status = DAVE Init();
079
080
081
              // Stop if DAVE init fails
082
              if (DAVE STATUS FAILURE == status)
083
               {
                   while (1U)
084
085
                  { ; }
086
              pal return status = test optiga communication();
087
880
089
              return (int32 t)pal return status;
090
```

#### **OPTIGA™ Trust M2 ID2 External Interface**



### 7 OPTIGA™ Trust M2 ID2 External Interface

#### 7.1 Commands

This section provides short description of the commands exposed by the OPTIGA™ Trust M2 ID2 secuirty chip and mapping of these commands w.r.t Use Cases.

Table 14 Command table

Command Name	Description			
OpenApplication	Command to launch an application			
CloseApplication	Command to close/hibernate an application			
GetDataObject	Command to get (read) a data object			
SetDataObject	Command to set (write) a data object			
SetObjectProtected	Command to set (write) data/key objects and its metadata protected (integrity			
	protection, confidentiality)			
GetRandom	Command to generate a random stream			
CalcHash	Command to calculate a Hash			
CalcSign	Command to calculate a signature			
VerifySign	Command to verify a signature			
DeriveKey	Command to derive keys			
GenKeyPair	Command to generate public/private key pairs			
EncryptAsym	Command to encrypt (Asymmetric) a message			
DecryptAsym	Command to decrypt (Asymmetric) a message			
EncryptSym	Command to encrypt (Symmetric) a message			
DecryptSym	Command to decrypt (Symmetric) a message			
GenSymKey	Command to generate a symmetric key			

Table 15 Mapping of commands with Use cases

Use Case	OPTIGA™ Trust M2 ID2 commands used
Secure Communication with (D)TLS	GetRandom, CalcHash, CalcSign, VerifySign, DeriveKey, GenKeyPair, EncryptAsym and DecryptAsym,
Symmetric Key Attestation, Security Tokens	EncryptSym and DecryptSym
Datastore (user memory ~ 4.5kB)	GetDataObject and SetDataObject
Secure Firmware Update	VerifySign and DeriveKey
Secure update of Trust Anchors and Keys on Security Chip	SetObjectProtected command

## 7.2 Crypto Performance

The performance metrics for various schemes are provided by the Table 16 below. If not particularly mentioned, the performance is measured @ OPTIGA™ Trust M2 ID2 I/O interface with:

- I2C FM (400KHz)
- Without power limitation
- @ 25°C
- VCC = 3.3V

#### **Product Version: V2**

# infineon

#### **OPTIGA™ Trust M2 ID2 External Interface**

RSA Signature scheme: RSA SSA PKCS#1 v1.5 without hashing

• Encryption/Decryption scheme: RSAES PKCS#1 v1.5

• Hash scheme: SHA256

• Key Derivation scheme: TLS v1.2 PRF SHA256, HKDF SHA256

RSA Key size: 2048 bitsAES Key size: 128 bits

#### Table 16 Crypto performance

Scheme	Algorithm	Performance in ms¹	Performance with Shielded	Notes	
			Connection in ms <sup>1</sup>		
Calculate signature	RSA®	~ 310	~ 320	<ul><li>2048 bit exponentical</li><li>No data hashing</li></ul>	
Verify signature	RSA®	~ 40	~ 50	<ul><li>2048 bit exponentical provided by external world</li><li>No data hashing</li></ul>	
Key pair generation	RSA®	~ 2900²	~ 2910	Generate 2048 bit RSA key pair	
Encryption	RSA®	~ 40	~ 50	Encrypt 127 bytes	
Decryption	RSA®	~ 315	~ 325	Decrypt 127 bytes	
Encryption	AES-128	~ 28	~ 35	Encrypt 256 bytes, ECB mode	
Decryption	AES-128	~ 35	~ 42	Decrypt 256 bytes, ECB mode	
Key derivation	PRF as per TLS v1.2	~ 50	~ 55	<ul> <li>To derive a key of 40 bytes</li> <li>Shared secret (32 bytes) from session context and</li> <li>The input key derivation data size is 48 bytes</li> </ul>	
Key derivation	HKDF with SHA256	~ 130	~ 135	Using a pre-shared secret from a data object	
НМАС	HMAC with SHA256	~ 90	~ 95	Using a pre-shared secret from a data object and 128 bytes of input data	
Hash calculation	SHA256	~ 15 Kbyte/s	~ 14 Kbyte/s	In blocks of 1280 bytes	

<sup>&</sup>lt;sup>1</sup>Minimum Execution of the entire sequence in milli seconds, except the External World timings

<sup>&</sup>lt;sup>2</sup> RSA key pair generation performance is not predictable and typically have a variation in performance. This could be significantly higher or lower as the one specified in the table which is an average value over collected samples.

#### **Product Version: V2**

### **Security Monitor**



## **8** Security Monitor

The Security Monitor is a central component which enforces the security policy of the OPTIGA™ Trust M2 ID2. It consumes security events sent by security aware parts of the OPTIGA™ Trust M2 ID2 embedded SW and takes actions accordingly as specified in Security Policy below.

### 8.1 Security Events

The events below actively influence the security monitor.

**Table 17 Security Events** 

Event	Description
Decryption Failure	This event occurs in case a decryption and/or integrity check of provided data lead to a failure during protected update
Key Derivation	This event occurs in case the DeriveKey command gets applied on a persistent data object (not volatile data object as session context). In that case the persistent data object gets used as pre-shared secret.
Private Key Use	This event occurs in case the internal services are going to use an OPTIGA™ Trust M2 ID2 hosted private key.
Secret Key Use	This event occurs in case the internal services are going to use a OPTIGA™ hosted secret (symmetric) key (once per respective command), except temporary keys from session context are used.
Suspect System Behavior	This event occurs in case the embedded software detects inconsistencies with the expected behavior of the system. Those inconsistencies might be redundant information which doesn't fit to their counterpart.

## 8.2 Security Policy

Security Monitor judges the notified security events regarding the number of occurrence over time and in case those violate the permitted usage profile of the system takes actions to throttle down the performance and thus the possible frequency of attacks.

The permitted usage profile is defined as:

- 1.  $t_{max}$  is set to 5 seconds ( $\pm$  5%)
- 2. A Suspect System Behavior event is never permitted and will cause setting the Security Event Counter (SEC) to its maximum (= 255).
- 3. One protected operation (refer to Table 17) events per  $t_{max}$  period.

In other words it must not allow more than one out of the protected operations per  $t_{max}$  period (worst case, ref to bullet 3. above). This condition must be stable, at least after 500 uninterrupted executions of protected operations.

For more information, please refer to Solution Reference Manual document available as part of the package.

#### **Product Version: V2**

**RoHS Compliance** 

9



**RoHS Compliance** 

On January 27, 2003 the European Parliament and the council adopted the directives:

- 2002/95/EC on the Restriction of the use of certain Hazardous Substances in electrical and electronic equipment ("RoHS")
- 2002/96/EC on Waste Electrical and Electrical and Electronic Equipment ("WEEE")

Some of these restricted (lead) or recycling-relevant (brominated flame retardants) substances are currently found in the terminations (e.g. lead finish, bumps, balls) and substrate materials or mold compounds.

The European Union has finalized the Directives. It is the member states' task to convert these Directives into national laws. Most national laws are available, some member states have extended timelines for implementation. The laws arising from these Directives have come into force in 2006 or 2007.

The electro and electronic industry has to eliminate lead and other hazardous materials from their products. In addition, discussions are on-going with regard to the separate recycling of ceratin materials, e.g. plastic containing brominated flame retardants.

Infineon Technologies is fully committed to giving its customers maximum support in their efforts to convert to lead-free and halogen-free<sup>1</sup> products. For this reason, Infineon Technologies' "Green Products" are ROHS-compliant.

Since all hazardous substances have been removed, Infineon Technologies calls its lead-free and halogen-free semiconductor packages "green." Details on Infineon Technologies' definition and upper limits for the restricted materials can be found here.

The assembly process of our high-technology semiconductor chips is an integral part of our quality strategy. Accordingly, we will accurately evaluate and test alternative materials in order to replace lead and halogen so that we end up with the same or higher quality standards for our products.

The use of lead-free solders for board assembly results in higher process temperatures and increased requirements for the heat resistivity of semiconductor packages. This issue is addressed by Infineon Technologies by a new classification of the Moisture Sensitivity Level (MSL). In a first step the existing products have been classified according to the new requirements.



<sup>&</sup>lt;sup>1</sup>Any material used by Infineon Technologies is PBB and PBDE-free. Plastic containing brominated flame retardants, as mentioned in the WEEE directive, will be replaced if technically/economically beneficial.

#### **Product Version: V2**



## Appendix A - Infineon I2C Protocol Registry Map

#### Appendix A - Infineon I2C Protocol Registry Map 10

OPTIGA™ Trust M2 ID2 supports IFX I2C v2.01 and is implemented as I2C slave, which uses different address locations for status, control and data communication registers. These registers with description are outlined below in the following table.

Table 18 **IFX I2C Registry Map Table** 

Register Address	Name	Size in Bytes	Description	Master Access
0x80	DATA	DATA_REG_LEN	This is the location where data shall be read from or written to the I2C slave	Read / Write
0x81	DATA_REG_LEN	2	This register holds the maximum data register (Addr 0x80) length. The allowed values are 0x0010 up to 0xFFFF. After writing the new data register length it becomes effective with the next I2C master access. However, in case the slave could not accept the new length it indicates its maximum possible length within this register. Therefore it is recommended to read the value back after writing it to be sure the I2C slave did accept the new value.  Note: the value of MAX_PACKET_SIZE is derived from this value or vice versa (MAX_PACKET_SIZE=DATA_REG_LEN-5)	Read / Write
0x82	I2C_STATE	4	Bits 31:24 of this register provides the I2C state in regards to the supported features (e.g. clock stretching) and whether the device is busy executing a command and/or ready to return a response etc.  Bits 15:0 defining the length of the response data block at the physical layer.	Read only
0x83	BASE_ADDR	2	This register holds the I2C base address as specified by Table 19. Default value is 0x30. After writing a different address the new address become effective with the next I2C master access. In case the bit 15 is set in addition to the new address (bit 6:0) it becomes the new default address at reset (persistent storage).	Write only
0x84	MAX_SCL_FREQU	4	This register holds the maximum clock frequency in KHz supported by the I2C slave. The value gets adjusted to the register I2C_Mode setting. Fast Mode (Fm): The allowed values are 50 up to 400. Fast Mode (Fm+): The allowed values are 50 up to 1000.	Read
0x85	GUARD_TIME <sup>1</sup>	4	For details refer to Table 22	Read only
0x86	TRANS_TIMEOUT <sup>1</sup>	4	For details refer to Table 22	Read only

<sup>&</sup>lt;sup>1</sup> In case the register returns 0xFFFFFFF the register is not supported and the default values specified in Table 'List of protocol variations' shall be applied.

#### **Product Version: V2**



## Appendix A - Infineon I2C Protocol Registry Map

Register Address	Name	Size in Bytes	Description	Master Access
0x88	SOFT_RESET	2	Writing to this register will cause a device reset. This feature is optional	Write only
0x89	I2C_MODE	2	This register holds the current I2C Mode as defined by Table 20. The default mode is SM & FM (011B).	Read / Write

#### Table 19 Definition of BASE\_ADDR

Fields	Bits	Value	Description
DEF_ADDR	15	0	Volatile address setting by bit 6:0, lost after reset.
		1	Persistent address setting by bit 6:0, becoming default after reset.
BASE_ADDR	6:0	0x00-0x7F	I <sup>2</sup> C base address specified by Table 18

15	14	13	12	11	10	9	8
DEF_ADDR				RFU			
7	6	5	4	3	2	1	0
RFU				BASE_ADDR			

15	14	13	12	11	10	9	8
DEF_MODE				RFU			
7	6	5	4	3	2	1	0
	RFU Mode						

#### Table 20 Definition of I2C\_MODE

Fields	Bits	Value	Description
DEF_MODE	15	0	Volatile mode setting by bit 2:0, lost after reset.  Persistent mode setting by bit 2:0, becoming
			default after reset. This bit is always read as 0.
MODE <sup>2</sup>	2:0	001	Sm
		010	Fm
		011	SM & Fm (fab out default)
		100	Fm+
		other values	not valid; writing will be ignored

 $<sup>^{\</sup>rm 1}$  In case the register returns 0xFFFFFFF the register and its functionality is not supported

 $<sup>^2\,</sup> This\, mode\, defines\, the\, adherence\, of\, the\, bus\, signals\, to\, the\, electrical\, characteristics\, according\, standard\, I2C\, bus\, specification$ 

#### **Product Version: V2**



## Appendix A - Infineon I2C Protocol Registry Map

31	30	29	28	27	26	25	24
BUSY	RESP_RDY	RI	-U	SOFT_RESET	CONT_READ	REP_START	CLK_STRETCHING
23	22	21	20	19	18	17	16
PRESENT_LAYER	YER RFU						
15-0							
Length of data block to be read							

Table 21 Definition of I2C\_STATE

Field	Bit(s)	Value	Description
BUSY	31	0	Device is not busy
		1	Device is busy executing a command
RESP_RDY	30	0	Device is not ready to return a response
		1	Device is ready to return a response
SOFT_RESET	27	0	SOFT_RESET not supported
		1	SOFT_RESET supported
CONT_READ	26	0	Continue Read not supported
		1	Continue Read supported
REP_START	25	0	Repeated start not supported
		1	Repeated start supported
CLK_STRETCHING	24	0	Clock stretching not supported
		1	Clock stretching supported
PRESENT_LAYER	23	0	Presentation Layer not supported
		1	Presentation Layer supported

#### 10.1 Infineon I2C Protocol Variations

To fit best to application specific requirements the protocol might be tailored by specifying a couple of parameters which is described in the following table.

**Table 22** List of Protocol Variations

Parameter	<b>Default Value</b>	Description			
MAX_PACKET_SIZE	0x110	Maximum packet size accepted by the receiver. The protoco limits this value to 0xFFFF, but there might be project specific requirements to reduce the transport buffers size for the sake o less RAM footprint in the communication stack. If shortened, i could be statically defined or negotiated at the physical layer.			
WIN_SIZE	1	Window size of the sliding windows algorithm. The value could be 1 up to 2.			
MAX_NET_CHAN	1	Maximum number of network channels. The value could be 1 up to 16. One indicates the OSI Layer 3 is not used and the CHAN field of the PCTR must be set to 0000.			
CHAINING	TRUE	Chaining on the transport layer is supported (TRUE) or not (FALSE)			
TRANS_TIMEOUT	10 ms	(Re) transmission timeout specifies the number of milliseconds to be elapsed until the transmitter considers a frame			

## **Product Version: V2**



## Appendix A - Infineon I2C Protocol Registry Map

Parameter	<b>Default Value</b>	Description
		transmission is lost and retransmits the non-acknowledged frame. The Timer gets started as soon as the complete frame is transmitted. The value could be 1 up to 1000. However, the higher the number, the longer it takes to recover from a frame transmission error.  Note: The acknowledge timeout on the receiver side must be shorter than the retransmission timeout to avoid unnecessary
		frame repetitions.
TRANS_REPEAT	3	Number of transmissions to be repeated until the transmitter considers the connection is lost and starts a re-synchronization with the receiver. The value could be 1 up to 4.
BASE_ADDR	0x30	I2C (base) address. This address could be statically defined or dynamically negotiated by the physical layer.
MAX_SCL_FREQU	1000 kHz	Maximum SCL clock frequency in kHz.
GUARD_TIME	50 μs	Minimum time to be elapsed at the I2C master measured from read data (STOP condition) until the next write data (Start condition) is allowed to happen.  Note 1: For two consecutive accesses on the same device GUARD_TIME re-specifies the value of t <sub>BUF</sub> as specified by [I2Cbus].  Note 2: Even if another I2C address is accessed in between GUARD_TIME has to be respected for two consecutive accesses on the same device.
SOFT_RESET	1	Any write attempt to the SOFT_RESET register will trigger a warm reset (reset w/o power cycle). This register is optional and its presence is indicated by the I2C_STATE register's "SOFT_RESET" flag.
PRESENT_LAYER	1	This flag at the I2C_STATE register indicates the optional availability of the presentation layer, which is providing confidentiality and integrity protection of payloads (APDUs) transferred across the I2C interface. The presentation layer is used as part of Shielded Connection.



## Appendix B - OPTIGA™ Trust M2 ID2 Command/Response I2C Sample Logs

## Appendix B - OPTIGA™ Trust M2 ID2 Command/Response I2C Sample Logs

The default I2C slave address for the OPTIGA™ Trust M2 ID2 is 0x30 [I2C\_ADDR]. All the values in this section are specified in decimal form unless stated otherwise.

## 11.1 Sequence of commands to read Coprocessor UID from OPTIGA™ Trust M2 ID2

#### **Pre-requisites**

- 1. Ensure that the security device is powered up
- 2. The OPTIGA™ Trust M2 ID2 will not acknowledge the slave address sent by a host if it is either busy or in idle state. Hence the host must retry or repeat the transaction until it is successful or timed out for 100 milliseconds (extreme case).
- 3. The specified guard time must be applied between each attempt of write / read operation by the Host 12C driver.
- 4. The log information for OPTIGA™ Trust M2 ID2 commands specified in below Tables contains the [IFX I2C] protocol information which comprises sequence numbers and checksum of the transactions.
  - a. A sequence of commands must be strict for the OPTIGA™ Trust M2 ID2 (e.g. OpenApplication followed by GetDataObject to read a Coprocessor UID)
  - b. A checksum in the data depends on the data received or sent via write/read operations. So any data change in the transaction is reflected in the check sum. Otherwise the write data transaction will not be accepted/acknowledged by the OPTIGA™ Trust M2 ID2.
- 5. The logs specified below are without the presentation layer (used for the Shielded Connection) of [IFX I2C]

## 11.1.1 Check the status [I2C\_STATE]

This is a very basic register read operation which ensures the behavior of the read/write operations of the local host I2C driver.

Table 23 Check I2C\_STATE Register of OPTIGA™ Trust M2 ID2

I2C_ADDR	Transaction Type	Data [values in hexadecimal]
30	Write [ 01 Bytes ]	82
30	Read [ 04 Bytes ]	08 80 00 00

#### 11.1.2 Issue OpenApplication command

Before issuing any application specific command; e.g. read Coprocessor UID using GetDataObject, it is a must to send the OpenApplication command to initialize the application on the OPTIGA™ Trust M2 ID2 as shown below.

Table 24 OpenApplication on OPTIGA™ Trust M2 ID2

I2C_ADDR	_ADDR Transaction Type Data [values in hexadecimal]	
Step 1: Send	OpenApplication comm	nand to initiate the application context on the OPTIGA™ Trust M2 ID2
30 Write [ 27 Bytes ]		80 03 00 15 00 <b>70 00 00 10 D2 76 00 00 04 47 65 6E 41 75 74 68 41</b>

**Product Version: V2** 



## Appendix B - OPTIGA™ Trust M2 ID2 Command/Response I2C Sample Logs

I2C_ADDR	Transaction Type	Data [values in hexadecimal]
		<b>70 70 6C</b> 04 1A
Step 2: Rea below]	d the I2C_STATE registe	r [Repeat this step until the read contains the data as specified
30	Write [ 01 Bytes ]	82
30	Read [ 04 Bytes ]	C8 80 00 05
Step 3: Rea	-	knowledgment from OPTIGA™ Trust M2 ID2 for the last data
30	Write [ 01 Bytes ]	80
30	Read [ 05 Bytes ]	80 00 00 0C EC
Step 4: Rea	d the I2C_STATE registe	r [Repeat this step until the read contains the data as specified
30	Write [ 01 Bytes ]	82
30	Read [ 04 Bytes ]	48 80 00 0A
Step 5: Rea	d the DATA register whic	ch contains the response for the command issued
Step 5: Rea	d the DATA register which Write [01 Bytes]	ch contains the response for the command issued  80
<u>-</u>		·
30	Write [ 01 Bytes ]	80 00 00 05 00 <b>00 00 00 1</b> 4 87

## 11.1.3 Read Coprocessor UID

The Coprocessor UID contains the OPTIGA™ Trust M2 ID2 unique ID and the build information details. The GetDataObject command is used to read the Coprocessor UID information.

Table 25 Read Coprocessor UID

I2C_ADDR	Transaction Type	Data [values in hexadecimal]
Step 1: Send	the GetDataObject co	ommand to read the Coprocessor UID
30	Write [ 17 Bytes ]	80 04 00 0B 00 <b>01 00 00 06 E0 C2 00 00 00 64</b> F0 9F
Step 2: Read	the I2C_STATE registo	er [Repeat this step until the read contains the data as specified below].
30	Write [ 01 Bytes ]	82
30	Read [ 04 Bytes ]	48 80 00 25
Step 3: Read	the DATA register whi	ich contains the response for the command issued.
30	Write [ 01 Bytes ]	80
30	Read [ 37 Bytes ]	05 00 20 00 <b>00 00 1B CD XX XX</b>
		Notes:
		a. XX is the unique ID part of the co-processor UID
		b. "YY YY" is the OPTIGA™ Trust M2 ID2 build number in BCD
		(Binary Coded Decimal) format
		c. ZZ ZZ is the checksum of the transaction

Step 4: Send an acknowlegment for the data read

**Product Version: V2** 



## Appendix B - OPTIGA™ Trust M2 ID2 Command/Response I2C Sample

Logs

I2C_ADDR	Transaction Type	Data [values in hexadecimal]
30	Write [ 06 Bytes ]	80 81 00 00 56 30

### **Appendix C - Power Management**

## 12 Appendix C – Power Management

When operating, the power consumption of OPTIGA<sup>TM</sup> Trust M2 ID2 is limited to meet the requirements regarding the power limitation set by the Host. The power limitation is implemented by utilizing the current limitation feature of the underlying hardware device in steps of 1mA from 6mA to 15 mA with a precision of  $\pm 5\%$ .

#### 12.1 Hibernation

This maximizes power saving (zero power consumption<sup>1</sup>), while the I2C bus stays connected. In this case OPTIGA<sup>TM</sup> Trust M2 ID2 saves the application context before power-off (switching off  $V_{CC}$ ) and restores it after power-up. After power-up the application continues seamlessly from the state before hibernate.

#### 12.2 Low Power Sleep Mode

The OPTIGA™ Trust M2 ID2 automatically enters a low-power mode after a configurable delay. Once it has entered Sleep mode, the OPTIGA™ Trust M2 ID2 resumes normal operation as soon as its address is detected on the I2C bus.

In case no command is sent to the OPTIGA™ Trust M2 ID2 it behaves as shown in Figure 13.

- 1. As soon as the OPTIGA™ Trust M2 ID2 is idle it starts to count down the "delay to sleep" time (tsdy).
- 2. In case this time elapses the device enters the "go to sleep" procedure.
- 3. The "go to sleep" procedure waits until all idle tasks are finished (e.g. counting down the SEC). In case all idle tasks are finished and no command is pending, the OPTIGA™ Trust M2 ID2 enters sleep mode.

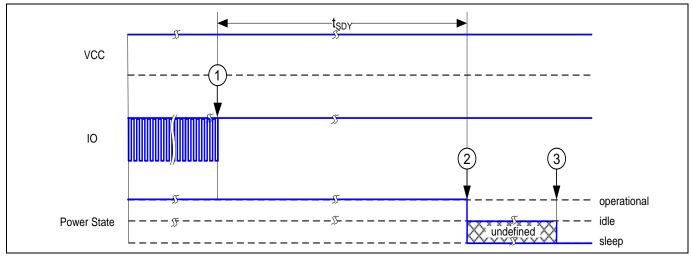


Figure 13 Go-to-Sleep Diagram

**Product Version: V2** 



## **Revision history**

## **Revision history**

<b>Document version</b>	Date of release	Description of changes
2.00	2020-06-29	Fixed internal review comments
0.70	2020-05-23	Initial version updated for ES Release

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Email:

**DSSCustomerService@infineon.com** 

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